

Silicon Carbide (SiC) MOSFET - EliteSiC, 14 mohm, 1200 V, M3P, D2PAK-7L NTBG014N120M3P

Features

- Typ. $R_{DS(on)} = 14 \text{ m}\Omega$
- Low Switching Losses (Typ. E_{ON} 1331 µJ at 74 A, 800 V)
- 100% Avalanche Tested

Typical Applications

- Solar Inverters
- Electric Vehicle Charging Stations
- UPS (Uninterruptible Power Supplies)
- Energy Storage Systems
- SMPS (Switch Mode Power Supplies)

MAXIMUM RATINGS (T_J = 25°C unless otherwise noted)

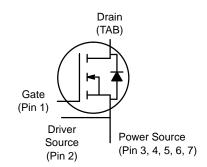
Symbol	Parameter			Value	Unit
V _{DSS}	Drain-to-Source Voltage			1200	V
V _{GS}	Gate-to-Source Voltage			-10 +22	V
V_{GSop}	Recommended Operation Values of Gate–Source Voltage	T _C < 175°C		-3/+18	٧
I _D	Continuous Drain Current $R_{\theta JC}$ (Note 2)	Steady State	T _C = 25°C	104	Α
P _D	Power Dissipation $R_{\theta JC}$ (Note 2)			454	W
I _D	Continuous Drain Current R ₀ JC (Note 1, 2)	Steady State	T _C = 100°C	73	A
P _D	Power Dissipation $R_{\theta JC}$ (Note 1, 2)			227	W
I _{DM}	Pulsed Drain Current (Note 3)	T _A = 25°C		257	А
T_J, T_STG	Operating Junction and Storage Temperature			-55 to 175	°C
IS	Source Current (Body Diode) $T_C = 25^{\circ}C$, $V_{GS} = -3 \text{ V}$			92	Α
E _{AS}	Single Pulse Drain–to–Source Avalanche Energy (Note 5) (I_L = 28.9 A_{pk} , L = 1 mH) (Note 4)			418	mJ
TL	Maximum Lead Temperature for Soldering, 1/8" from Case for 10 seconds			245	°C

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

- 1. Surface mounted on a FR-4 board using 1 in² pad of 2 oz copper.
- The entire application environment impacts the thermal resistance values shown, they are not constants and are only valid for the particular conditions noted.
- 3. Repetitive rating, limited by max junction temperature.
- 4. Peak current might be limited by transconductance.
- 5. E_{AS} of 418 mJ is based on starting T_J = 25°C; L = 1 mH, I_{AS} = 28.9 A, V_{DD} = 100 V, V_{GS} = 18 V.

V _{(BR)DSS}	R _{DS(ON)} MAX	I _D MAX	
1200 V	20 mΩ @ 18 V	104 A	

N-CHANNEL MOSFET





D2PAK-7L CASE 418BJ

MARKING DIAGRAM

BG014N 120M3P O AYWWZZ

A = Assembly Location
Y = Year
WW = Work Week
ZZ = Lot Traceability
BG014N120M3P = Specific Device Code

ORDERING INFORMATION

Device	Package	Shipping [†]
NTBG014N120M3P	D2PAK-7L	800 / Tape & Reel

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specification Brochure, BRD8011/D.

THERMAL CHARACTERISTICS

Symbol	Parameter	Тур	Max	Unit
$R_{ heta JC}$	Thermal Resistance Junction-to-Case (Note 2)	0.33	-	°C/W
$R_{ heta JA}$	Thermal Resistance Junction-to-Ambient (Note 1, 2)	_	40	°C/W

Symbol	Parameter	Test Conditions	Min	Тур	Max	Unit
OFF-STATE C	HARACTERISTICS	l .	ı			1
V _{(BR)DSS}	Drain-to-Source Breakdown Voltage	V _{GS} = 0 V, I _D = 1 mA	1200			V
V _{(BR)DSS} / T _J	Drain-to-Source Breakdown Voltage Temperature Coefficient	I _D = 1 mA, refer to 25°C		0.3		mV/°C
I _{DSS}	Zero Gate Voltage Drain Current	$V_{GS} = 0 \text{ V}, V_{DS} = 1200 \text{ V}, $ $T_{J} = 25 ^{\circ}\text{C}$			100	μΑ
I _{GSS}	Gate-to-Source Leakage Current	V _{GS} = +22/-10 V, V _{DS} = 0 V			±1	μΑ
ON-STATE CH	IARACTERISTICS					
V _{GS(TH)}	Gate Threshold Voltage	$V_{GS} = V_{DS}$, $I_D = 37 \text{ mA}$	2.08	3.0	4.63	V
V _{GOP}	Recommended Gate Voltage		-3		+18	V
R _{DS(on)}	Drain-to-Source On Resistance	$V_{GS} = 18 \text{ V, } I_D = 74 \text{ A,}$ $T_J = 25^{\circ}\text{C}$		14	20	mΩ
		V _{GS} = 18 V, I _D = 74 A, T _J = 175°C		29		mΩ
		$V_{GS} = 15 \text{ V, } I_D = 74 \text{ A,}$ $T_J = 25^{\circ}\text{C}$		16	27	mΩ
		V _{GS} = 15 V, I _D = 74 A, T _J = 150°C		27		mΩ
9FS	Forward Transconductance	V _{DS} = 10 V, I _D = 74 A		29		S
CHARGES, CA	APACITANCES & GATE RESISTANCE					
C _{ISS}	Input Capacitance	V _{GS} = 0 V, f = 1 MHz,		6313		pF
C _{OSS}	Output Capacitance	V _{DS} = 800 V		259		-
C _{RSS}	Reverse Transfer Capacitance			27		
Q _{G(TOT)}	Total Gate Charge	$V_{GS} = -3/18 \text{ V},$		337		nC
Q _{G(TH)}	Threshold Gate Charge	V _{DS} = 800 V, I _D = 74 A		43		
Q_{GS}	Gate-to-Source Charge			78		7
Q_{GD}	Gate-to-Drain Charge			98		
R_{G}	Gate Resistance	f = 1 MHz		1.4		Ω
SWITCHING C	HARACTERISTICS					
t _{d(ON)}	Turn-On Delay Time	$V_{GS} = -3/18 \text{ V}, V_{DS} = 800 \text{ V}$		24		ns
t _r	Rise Time	I _D = 74 A, R _G = 2 Ω		40		
t _{d(OFF)}	Turn-Off Delay Time			7		
t _f	Fall Time			14		
E _{ON}	Turn-On Switching Loss			1331		μJ
E _{OFF}	Turn-Off Switching Loss			620		
E _{TOT}	Total Switching Loss			1951		

ELECTRICAL CHARACTERISTICS ($T_J = 25^{\circ}C$ unless otherwise noted) (continued)

Symbol	Parameter	Test Conditions	Min	Тур	Max	Unit
DRAIN-SOU	RCE DIODE CHARACTERISTICS	•				•
I _{SD}	Continuous Drain-Source Diode Forward Current	$V_{GS} = -3 \text{ V}, T_{C} = 25^{\circ}\text{C}$			92	А
I _{SDM}	Pulsed Drain–Source Diode Forward Current (Note 3)	$V_{GS} = -3 \text{ V}, T_C = 25^{\circ}\text{C}$			257	А
V_{SD}	Forward Diode Voltage	$V_{GS} = -3 \text{ V, } I_{SD} = 74 \text{ A,}$ $T_{J} = 25^{\circ}\text{C}$		5.1		V
t _{RR}	Reverse Recovery Time	$V_{GS} = -3/18 \text{ V}, I_{SD} = 74 \text{ A},$		37		ns
Q _{RR}	Reverse Recovery Charge	$dI_S/dt = 1000 \text{ A/}\mu\text{s}, \text{ V}, V_{DS} = 800 \text{ V}$		347		nC
E _{REC}	Reverse Recovery Energy			12		μJ
I _{RRM}	Peak Reverse Recovery Current			19		Α
t _A	Charge Time			19		ns
t _B	Discharge Time			17		ns

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

6. E_{ON}/E_{OFF} result is with body diode.

TYPICAL CHARACTERISTICS

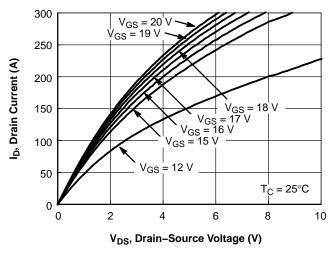


Figure 1. On-Region Characteristics

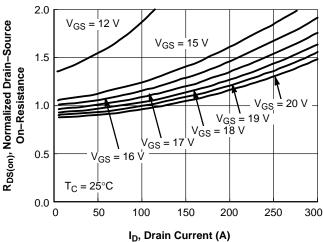


Figure 2. Normalized On–Resistance vs.
Drain Current and Gate Voltage

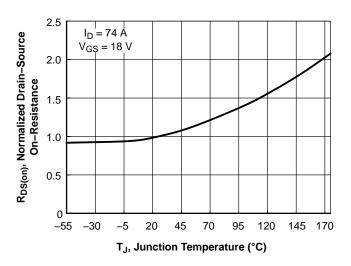


Figure 3. On–Resistance Variation with Temperature

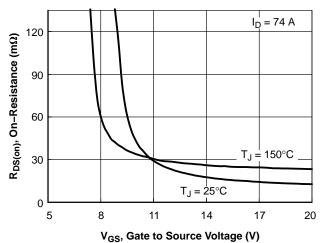


Figure 4. On-Resistance vs. Gate-to-Source Voltage

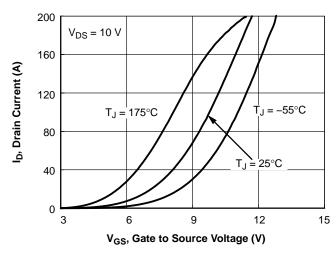


Figure 5. Transfer Characteristics

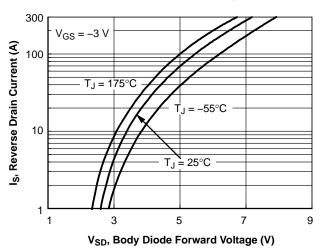


Figure 6. Diode Forward Voltage vs. Current

TYPICAL CHARACTERISTICS (CONTINUED)

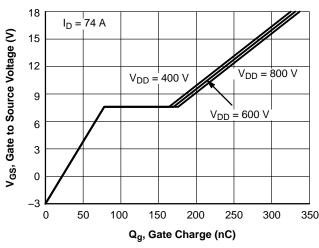


Figure 7. Gate-to-Source Voltage vs. Total Charge

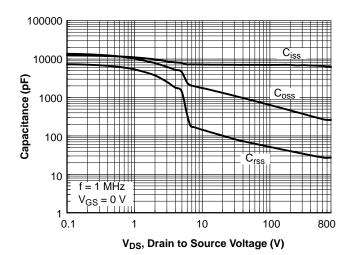


Figure 8. Capacitance vs. Drain to Source Voltage

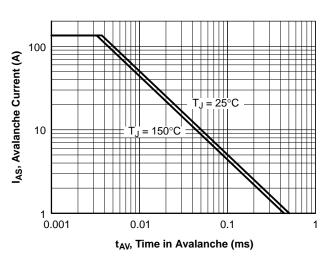


Figure 9. Unclamped Inductive Switching Capability

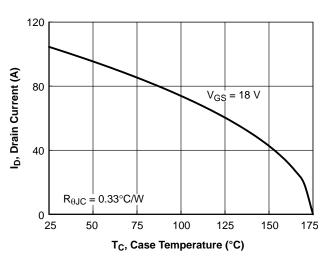


Figure 10. Maximum Continuous Drain Current vs. Case Temperature

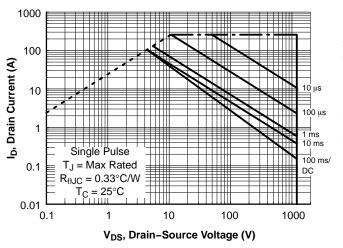


Figure 11. Safe Operating Area

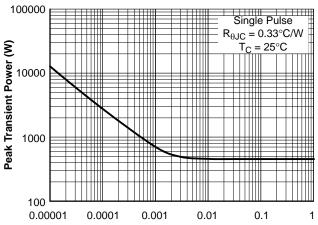


Figure 12. Single Pulse Maximum Power Dissipation

TYPICAL CHARACTERISTICS (CONTINUED)

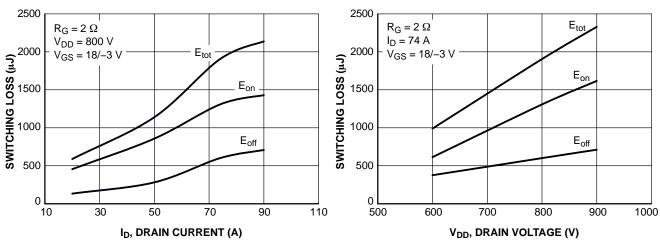


Figure 13. Switching Loss vs. Drain Current

Figure 14. Switching Loss vs. Drain Voltage

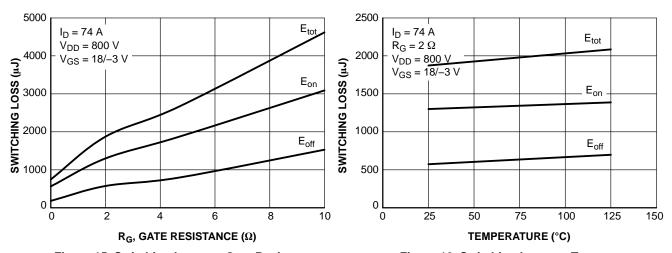


Figure 15. Switching Loss vs. Gate Resistance

Figure 16. Switching Loss vs. Temperature

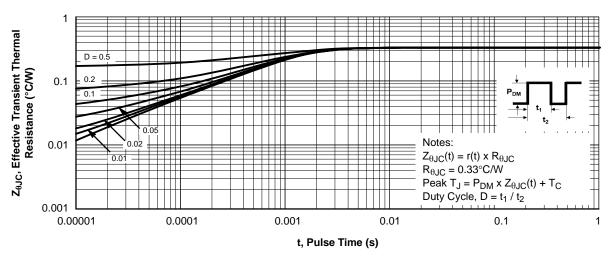


Figure 17. Junction-To-Case Transient Thermal Response Curve

1

D²PAK7 (TO-263-7L HV) CASE 418BJ **ISSUE B**

DATE 16 AUG 2019

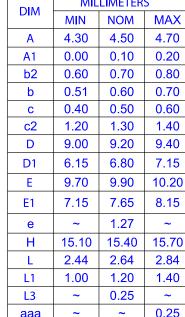
NOTES:

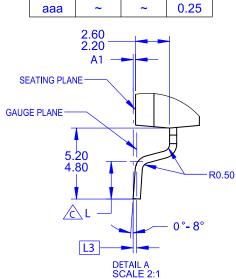
- A. PACKAGE CONFORMS TO JEDEC TO-263 VARIATION CB EXCEPT WHERE NOTED. B. ALL DIMENSIONS ARE IN MILLIMETERS.
- OUT OF JEDEC STANDARD VALUE.

 D. DIMENSION AND TOLERANCE AS PER ASME Y14.5-2009.

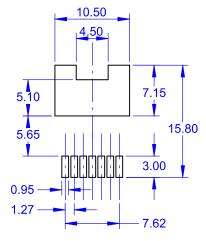
 E. DIMENSIONS ARE EXCLUSIVE OF BURRS, MOLD FLASH AND TIE BAR PROTRUSIONS.

DIM	MILLIMETERS			
DIM	MIN	NOM	MAX	
Α	4.30	4.50	4.70	
A1	0.00	0.10	0.20	
b2	0.60	0.70	0.80	
b	0.51	0.60	0.70	
С	0.40	0.50	0.60	
c2	1.20	1.30	1.40	
D	9.00	9.20	9.40	
D1	6.15	6.80	7.15	
Е	9.70	9.90	10.20	
E1	7.15	7.65	8.15	
е	~	1.27	~	
Н	15.10	15.40	15.70	
L	2.44	2.64	2.84	
L1	1.00	1.20	1.40	
L3	~	0.25	~	
aaa	~	~	0.25	

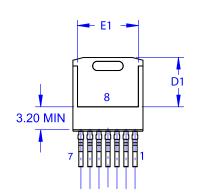




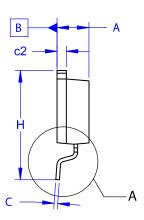
A	— E —	_ L
D		
1		
b2 →		
e	h —	_



LAND PATTERN RECOMMENDATION



⊕ | aaa | B | A | M |



GENERIC MARKING DIAGRAM*



XXXX = Specific Device Code = Assembly Location

= Year WW = Work Week = Pb-Free Package

*This information is generic. Please refer to

device data sheet for actual part marking.
Pb-Free indicator, "G" or microdot "■", may
or may not be present. Some products may
not follow the Generic Marking.
· ·

DOCUMENT NUMBER:	98AON84234G	Electronic versions are uncontrolled except when accessed directly from Printed versions are uncontrolled except when stamped "CONTROLLED"	
DESCRIPTION:	D ² PAK7 (TO-263-7L HV)		PAGE 1 OF 1

ON Semiconductor and are trademarks of Semiconductor Components Industries, LLC dba ON Semiconductor or its subsidiaries in the United States and/or other countries. ON Semiconductor reserves the right to make changes without further notice to any products herein. ON Semiconductor makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does ON Semiconductor assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. ON Semiconductor does not convey any license under its patent rights nor the rights of others.

onsemi, ONSEMI, and other names, marks, and brands are registered and/or common law trademarks of Semiconductor Components Industries, LLC dba "onsemi" or its affiliates and/or subsidiaries in the United States and/or other countries. onsemi owns the rights to a number of patents, trademarks, copyrights, trade secrets, and other intellectual property. A listing of onsemi's product/patent coverage may be accessed at www.onsemi.com/site/pdf/Patent-Marking.pdf. Onsemi reserves the right to make changes at any time to any products or information herein, without notice. The information herein is provided "as-is" and onsemi makes no warranty, representation or guarantee regarding the accuracy of the information, product features, availability, functionality, or suitability of its products for any particular purpose, nor does onsemi assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. Buyer is responsible for its products and applications using onsemi products, including compliance with all laws, regulations and safety requirements or standards, regardless of any support or applications provided by onsemi. "Typical" parameters which may be provided in onsemi data sheets and/or specifications can and do vary in different applications and actual performance may vary over time. All operating parameters, including "Typicals" must be validated for each customer application by customer's technical experts. onsemi does not convey any license under any of its intellectual property rights nor the rights of others. onsemi products are not designed, intended, or authorized for use as a critical component in life support systems or any EDA class 3 medical devices or medical devices with a same or similar classification in a foreign jurisdiction or any devices intended for implantation in the human body. Should Buyer pu

PUBLICATION ORDERING INFORMATION

LITERATURE FULFILLMENT:
Email Requests to: orderlit@onsemi.com

onsemi Website: www.onsemi.com

TECHNICAL SUPPORT North American Technical Support: Voice Mail: 1 800-282-9855 Toll Free USA/Canada Phone: 011 421 33 790 2910

Europe, Middle East and Africa Technical Support:

Phone: 00421 33 790 2910

For additional information, please contact your local Sales Representative

X-ON Electronics

Largest Supplier of Electrical and Electronic Components

Click to view similar products for MOSFET category:

Click to view products by ON Semiconductor manufacturer:

Other Similar products are found below:

NTNS3A92PZT5G IRFD120 IRFF430 JANTX2N5237 2N7000 2SK2464-TL-E 2SK2267(Q) 2SK2545(Q,T) 405094E 423220D

MIC4420CM-TR VN1206L 614234A 715780A 751625C IRS2092STRPBF-EL IPS70R2K0CEAKMA1 SQD23N06-31L-GE3

BSF024N03LT3 G PSMN4R2-30MLD 2SK2614(TE16L1,Q) DMN1017UCP3-7 EFC2J004NUZTDG P85W28HP2F-7071 DMN1053UCP4
7 NTE2384 NTE6400A DMC2700UDMQ-7 DMN2080UCB4-7 DMN61D9UWQ-13 US6M2GTR DMN31D5UDJ-7 DMP22D4UFO-7B

IPS60R3K4CEAKMA1 DMN1006UCA6-7 DMN16M9UCA6-7 STF5N65M6 IRF40H233XTMA1 IPSA70R950CEAKMA1

IPSA70R2K0CEAKMA1 STU5N65M6 C3M0021120D DMN6022SSD-13 DMN13M9UCA6-7 DMTH10H4M6SPS-13

IPS60R360PFD7SAKMA1 DMN2990UFB-7B SSM3K35CT,L3F IPLK60R1K0PFD7ATMA1 2N7002W-G